

1.0A SCHOTTKY BARRIER RECTIFIER CHIP SCALE PACKAGE
Product Summary

V_{RRM} (V)	I_O (A)	V_{F max} (V)	I_{R max} (µA)
40	1.0	0.48	100

Description and Applications

The DIODES™ SDM1U40CSP is a 40V 1A Schottky Barrier Rectifier optimized for low forward voltage drop and low-leakage current. Housed in a compact chip scale package (CSP), the SDM1U40CSP occupies only 0.84 mm² board-space with low profile. The low thermal resistance enables designers to meet design challenges of increasing efficiency whilst at the same time reducing board space. It is ideally suited for use in portable applications as a:

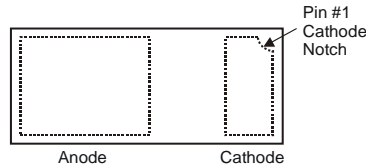
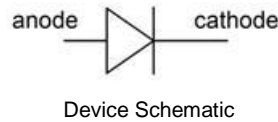
- Blocking diode
- Boost diode
- Switching diode
- Reverse protection diode

Features and Benefits

- Low Forward Voltage (V_F) Minimizes Conduction Losses and Improves Efficiency
- Reduced High Temperature Reverse Leakage
- Increased Reliability Against Thermal Runaway Failure in High Temperature Operation
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. “Green” Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

Mechanical Data

- Package: X3-WLB1406-2
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity: Cathode Dot
- Weight: 0.001 grams (Approximate)


Ordering Information (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
SDM1U40CSP-7	X3-WLB1406-2	5000	Tape & Reel

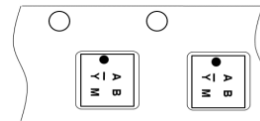
- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information

Pin 1



X1 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: J = 2022)
 M = Month (ex: 1 = January)
 Dot denotes Cathode Pin


Date Code Key

Year	2014	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	B	J	K	L	M	N	O	P	R	S	T
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	40	V
Average Rectified Output Current	I _O	1.0	A
Repetitive Peak Forward Current (Pulse Wave = 1 sec, Duty Cycle = 66%)	I _{FRM}	5.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	18	A

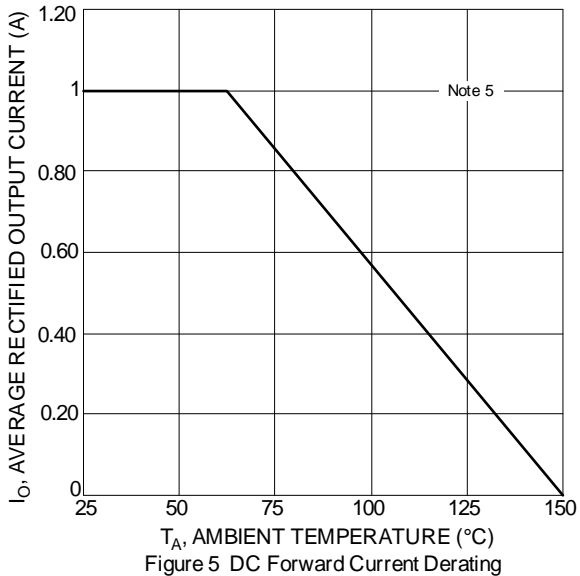
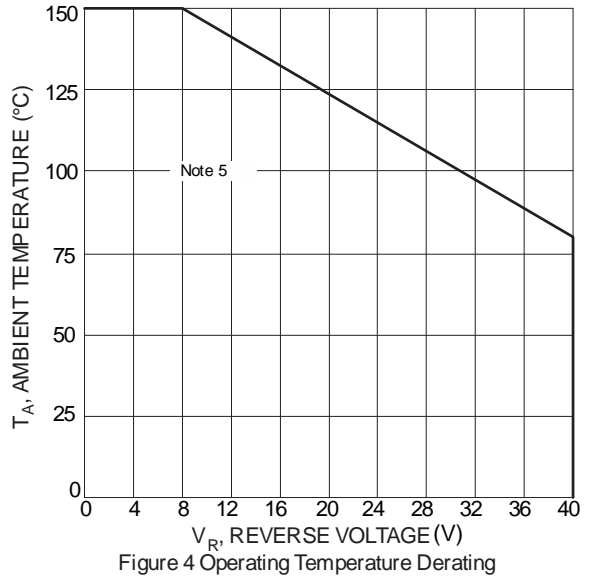
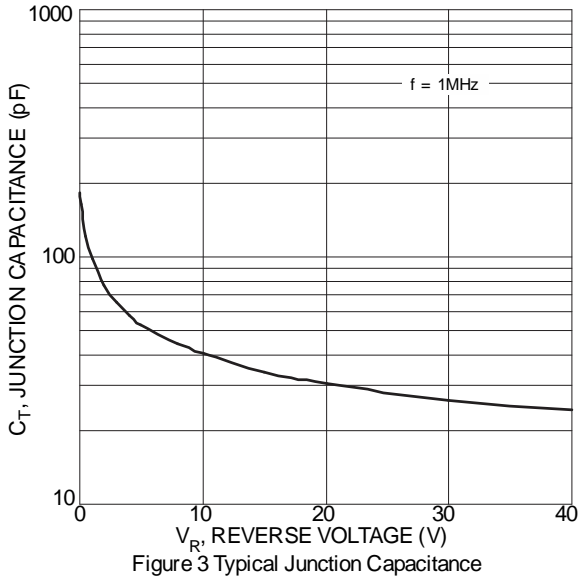
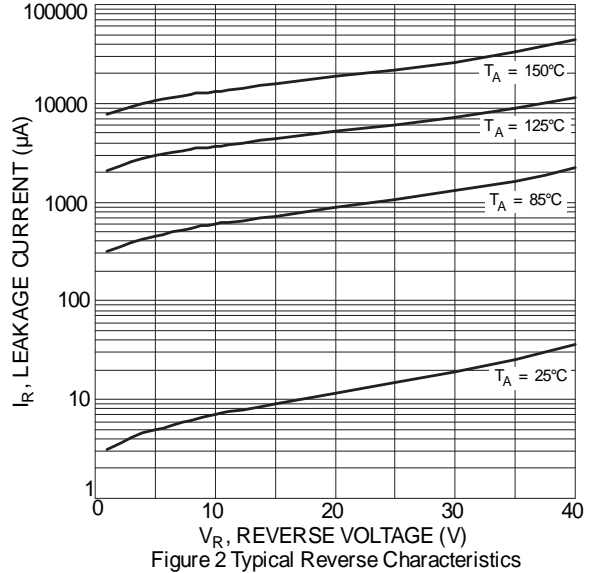
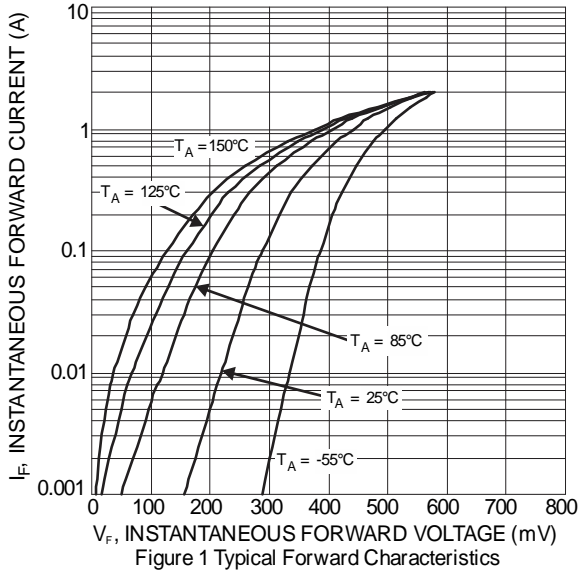
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{θJA}	190	°C/W
Typical Thermal Resistance Junction to Ambient (Note 6)	R _{θJA}	105	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V _F	—	0.37	0.41	V	I _F = 0.5A
		—	0.44	0.48		I _F = 1.0A
Reverse Current (Note 7)	I _R	—	—	22	μA	V _R = 10V
		—	—	100		V _R = 40V
Junction Capacitance	C _J	—	58	—	pF	V _R = 4V, f = 1.0MHz

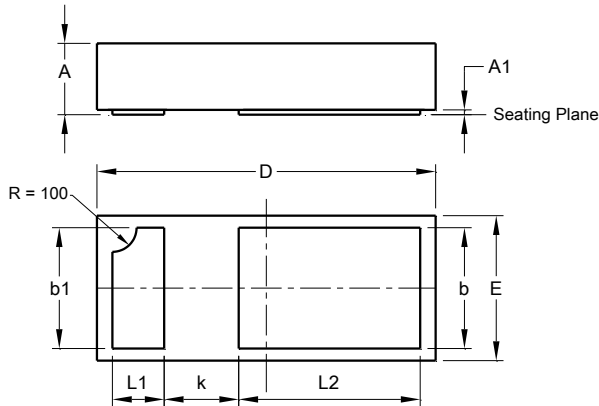
Notes: 5. Device mounted on FR-4 PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
6. Device mounted on FR-4 PCB, 2oz. 1 square inch Copper.
7. Short duration pulse test used to minimize self-heating effect.



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X3-WLB1406-2

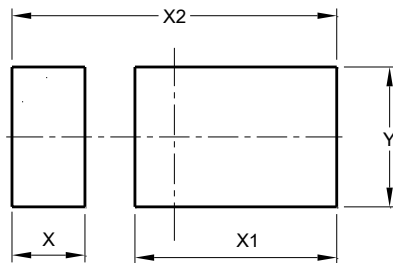


X3-WLB1406-2			
Dim	Min	Max	Typ
A	0.250	0.300	0.275
A1	0.000	0.015	—
b	0.45	0.55	—
b1	0.45	0.55	—
D	1.37	1.43	1.40
E	0.57	0.63	0.60
k	—	—	0.30
L1	0.20	0.26	—
L2	0.70	0.80	—
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

X3-WLB1406-2



Dimensions	Value (in mm)
X	0.304
X1	0.840
X2	1.352
Y	0.580

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